

Surface Mount - 800V > BTB12-600CW3G, BTB12-800CW3G

BTB12-600CW3G, BTB12-800CW3G



Description

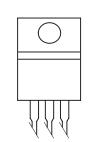
Designed for high performance full-wave ac control applications where high noise immunity and high commutating di/dt are required.

Features

- Blocking Voltage to 800 V
- On-State Current Rating of 12 Amperes RMS at 25°C
- Uniform Gate Trigger Currents in Three Quadrants
- High Immunity to dV/dt 1500 V/ μ s minimum at 125°C
- Minimizes Snubber Networks for Protection
- Industry Standard TO-220AB Package
- High Commutating dl/dt 3.0. A/ms minimum at 125°C
- These are Pb-Free Devices



Pin Out



Functional Diagram

Additional Information



Resources



Po

Samples



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Maximum Ratings ($T_{J} = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) (Gate Open, Sine Wave 50 to 60 Hz, T _J = -40° to 125°C) BTB12–600BW3G BTB12–800BW3G	V _{drm} , V _{rrm}	600 800	V
On-State RMS Current (Full Cycle Sine Wave, 60 Hz, $T_c = 80^{\circ}C$)	I _{T (RMS)}	12	А
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T _c = 25°C)	I _{tsm}	120	А
Circuit Fusing Consideration (t = 10 ms)	l²t	78	A ² sec
Non-Repetitive Surge Peak Off-State Voltage $(T_j = 25^{\circ}C, t = 10 \text{ ms})$	V _{dsm} /V _{rsm}	V _{DSM} /V _{RSM} +100	V
Peak Gate Current (T _J = 125°C, t = 20ms)	I _{GM}	4.0	W
Peak Gate Power (Pulse Width \leq 1.0 µs, T _c = 80°C)	P _{GM}	20	W
Average Gate Power ($T_J = 125^{\circ}C$)	P _{G(AV)}	1.0	W
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T _{stg}	-40 to +125	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Thermal Characteristics

Rating		Symbol	Value	Unit
Thermal Resistance,	Junction-to-Case (AC)	R _{sJC}	2.3	°C/W
	Junction-to-Ambient	R _{8JA}	60	0,00
Maximum Lead Temperature for Sol 10 seconds	dering Purposes, 1/8" from case for	TL	260	°C

Electrical Characteristics • OFF (T₁ = 25°C unless otherwise noted ; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Blocking Current	$T_{J} = 25^{\circ}C$	I _{DRM} ,	-	-	0.005	
$(V_{D} = V_{DRM} = V_{RRM}; \text{ Gate Open})$	T _J = 125°C	I _{RRM}	-	-	1.0	mA

Electrical Characteristics - **ON** ($T_{J} = 25^{\circ}$ C unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Forward On-State Voltage (Note 2) ($I_{TM} = \pm 17$ A Peak)		V _{TM}	-	-	1.55	V
Gate Trigger Current (Continuous dc) ($V_p = 12 \text{ V}, \text{ R}_L = 30 \Omega$)	MT2(+), G(+)		2.0	-	35	
	MT2(+), G(-)	I _{GT}	2.0	-	35	mA
	MT2(-), G(-)		2.0	-	35	
Holding Current (V _D = 12 V, Gate Open, Initiating Current = ±100 mA)		I _H	_	_	45	mA
	MT2(+), G(+)		-	-	50	
Latching Current ($V_{D} = 12$ V, $I_{G} = 42$ mA)	MT2(+), G(-)	I.	_	_	80	mA
	MT2(-), G(-)		-	-	50	
	MT2(+), G(+)		0.5	-	1.7	
Gate Trigger Voltage (V $_{\rm D}$ = 12 V, R $_{\rm L}$ = 30 $\Omega)$	MT2(+), G(-)	V _{gt}	0.5	-	1.1	V
	MT2(-), G(-)		0.5	-	1.1	
	MT2(+), G(+)		0.2	-	-	
Gate Non-Trigger Voltage ($T_J = 125^{\circ}C$)	MT2(+), G(-)	V _{gd}	0.2	-	-	V
	MT2(-), G(-)		0.2	-	-	

2. Indicates Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.



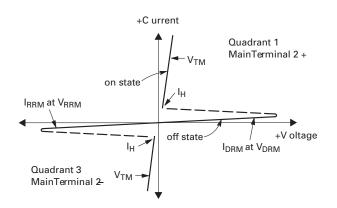
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D	vnamic	Charac	teristics

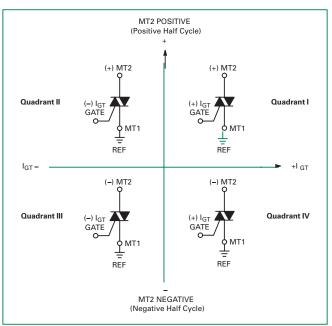
Characteristic	Symbol	Min	Тур	Max	Unit
Rate of Change of Commutating Current, See Figure 10. (Gate Open, T _J = 125°C, No Snubber)	(dl/dt)c	3.0	_	_	A/ms
Critical Rate of Rise of On–State Current $(T_J = 125^{\circ}C, f = 120 \text{ Hz}, I_G = 2 \times I_{GT}, \text{ tr} \le 100 \text{ ns})$	dl/dt	_	_	50	A/µs
Critical Rate of Rise of Off-State Voltage ($V_D = 0.66 \times V_{DRM}$, Exponential Waveform, Gate Open, $T_J = 125^{\circ}$ C)	dV/dt	1500	_	_	V/µs

Voltage Current Characteristic of SCR

Symbol	Parameter
V _{DRM}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current



Quadrant Definitions for a Triac



All polarities are referenced to MT1. With in-phase signals (using standard AC lines) quadrants I and III are used.



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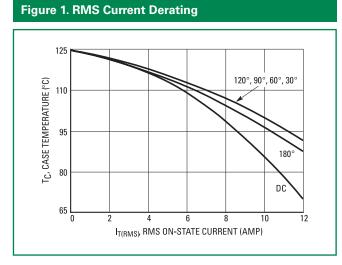


Figure 3. On–State Characteristics

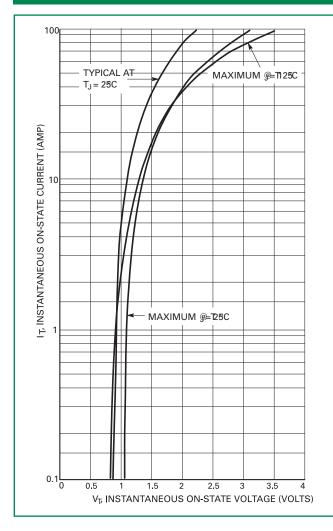


Figure 2. On-State Power Dissipation

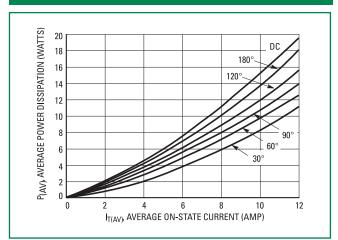


Figure 4. Thermal Response

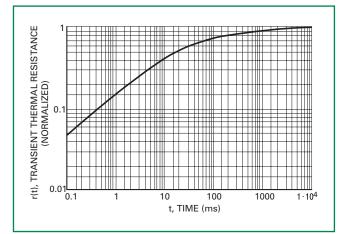
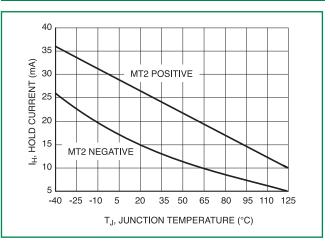


Figure 5. Typical Hold Current Variation





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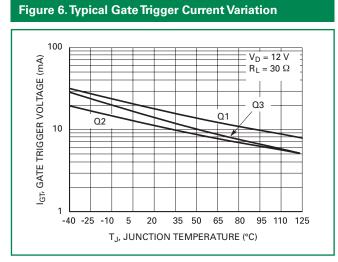


Figure 8. Critical Rate of Rise of Off-State Voltage (Exponential Waveform)

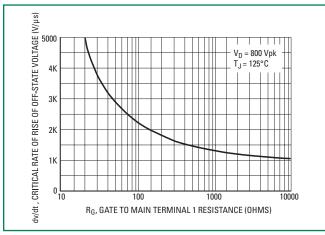


Figure 7. Typical Gate Trigger Voltage Variation

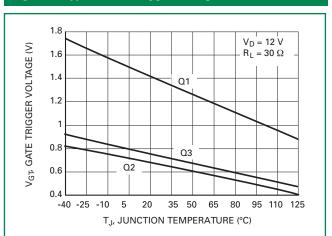
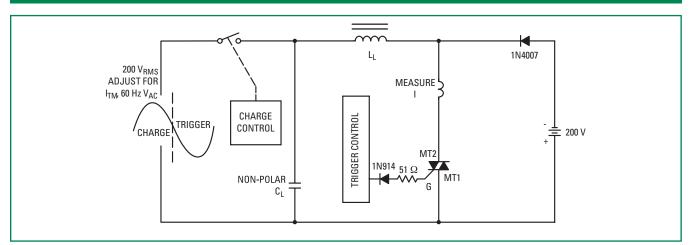


Figure 9. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)



Note: Component values are for verification of rated (di/dt)c. See AN1048 for additional information



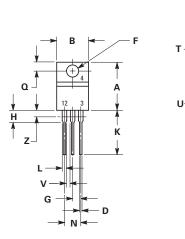
-T- SEATING PLANE

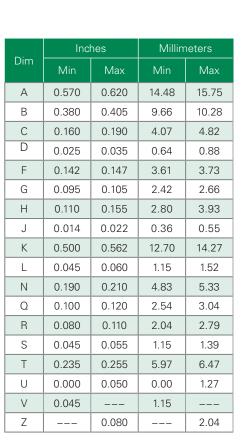
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Surface Mount - 800V > BTB12-600CW3G, BTB12-800CW3G

Dimensions





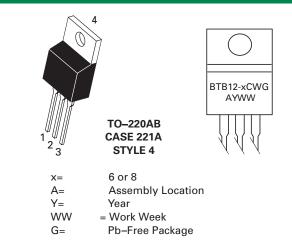
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

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Part Marking System



Pin Assignment	
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

Ordering Information

Device	Package	Shipping
BTB12-600CW3G	TO-220AB (Pb-Free)	50 Units / Rail
BTB12-800CW3G	TO-220AB (Pb-Free)	50 Units / Rail